



Product Change Notification

Change Notification #: 118562-00
Change Title: Intel® Storage Adapter RSP3QD160J,
PCN 118562-00, Product Design, Product
Material
Second Source Component and Firmware
Update
Date of Publication: October 13, 2021

Key Characteristics of the Change:

Product Design, Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material*:	October 28, 2021
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

The Intel SKUs listed in the products affected table will have the following changes.

1. Change in resistor placement in the memory voltage regulator circuit order to allow 1.8V NOR flash memory. This is to allow a second source memory vendor.
2. Update the firmware to version 06.00.10.00 (PH 6 on firmware package 06.00.10.01)

Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers. Please contact your local Intel Field Sales Rep if you have any further questions about these changes

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
Intel® Storage Adapter RSP3QD160J, 5 Pack	RSP3QD160J	954491	J40727-002	J40735-201	J40727-003	J40735-202

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
October 13, 2021	00	Originally Published PCN



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118562-00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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